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<u>Silicon Carbide (SiC)</u> <u>MOSFET</u> – EliteSiC, 23 mohm, 650 V, M3S, TOLL NTBL023N065M3S

Features

- Typical $R_{DS(on)} = 23 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge ($Q_{G(tot)} = 69 \text{ nC}$)
- High Speed Switching with Low Capacitance ($C_{oss} = 152 \text{ pF}$)
- 100% Avalanche Tested
- This Device is Halide Free and RoHS Compliant with Exemption 7a, Pb–Free 2LI (on second level interconnection)

Applications

- SMPS (Switching Mode Power Supplies)
- Solar Inverters
- UPS (Uninterruptable Power Supplies)
- Energy Storage
- Infrastructure

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

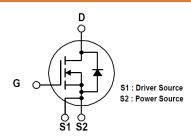
Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	650	V
Gate-to-Source Voltage		V _{GS}	-8/+22	V
Continuous Drain Current	T _C = 25°C	I _D	77	А
Power Dissipation		PD	312	W
Continuous Drain Current	$T_{C} = 100^{\circ}C$	I _D	54	А
Power Dissipation		PD	156	W
Pulsed Drain Current (Note 1)	T _C = 25°C t _p = 100 μs	I _{DM}	280	А
Continuous Source-Drain Current (Body Diode)	$\begin{array}{l} T_{C}=25^{\circ}C,\\ V_{GS}=-3~V \end{array}$	I _S	46	A
	$\begin{array}{l} T_C = 100^\circ C, \\ V_{GS} = -3 \ V \end{array}$		27	
Pulsed Source-Drain Current (Body Diode) (Note 1)	$\begin{array}{l} T_{C} = 25^{\circ}C, \\ V_{GS} = -3 \; V, \\ t_{p} = 100 \; \mu s \end{array}$	I _{SM}	274	A
Single Pulse Avalanche Energy (I _{LPK} = 19.6 A, L = 1 mH) (Note 2)		E _{AS}	192	mJ
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating, limited by max junction temperature.

2. E_{AS} of 192 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 19.6 A, V_{DD} = 100 V, V_{GS} = 18 V.

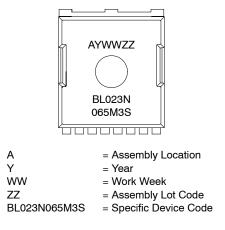
V _{DSS}	R _{DS(ON)} TYP	I _D MAX
650 V	23 mΩ @ 18 V	77 A







MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 3)	$R_{\theta JC}$	0.48	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	R_{\thetaJA}	43	°C/W

3. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

RECOMMENDED OPERATING CONDITIONS

Parameter		Value	Unit
Operation Values of Gate-to-Source Voltage		-53/+18	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 1 mA$	650			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	${\Delta V_{(BR)DSS} \over /\Delta T_J}$	$I_D = 1$ mA, Referenced to 25°C		89		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 650 V, T_J = 25°C			10	μA
		V _{DS} = 650 V, T _J = 175°C (Note 5)			500	μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = -8/+22$ V, $V_{DS} = 0$ V			±1	μA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 18 V, I _D = 20 A, T _J = 25°C		23	32.6	mΩ
		V_{GS} = 18 V, I _D = 20 A, T _J = 175°C		34		
		V_{GS} = 15 V, I _D = 20 A, T _J = 25°C		29		
		V _{GS} = 15 V, I _D = 20 A, T _J = 175°C		37		
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 10 \text{ mA}$	2		4	V
Forward Transconductance	9 FS	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		14		S
CHARGES, CAPACITANCES & GATE R	ESISTANCE					
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 400 V (Note 5)		1950		pF
Output Capacitance	C _{OSS}			152		
Reverse Transfer Capacitance	C _{RSS}			13		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -3/18 \text{ V}, V_{DD} = 400 \text{ V},$		69		nC
Gate-to-Source Charge	Q _{GS}	I _D = 20 A (Note 5)		19		
Gate-to-Drain Charge	Q _{GD}			18		
Gate-Resistance	R _G	f = 1 MHz		4.0		Ω
SWITCHING CHARACTERISTICS						
Turn–On Delay Time	t _{d(ON)}	$V_{GS} = -3/18$ V, $V_{DD} = 400$ V,		11		ns
Turn-Off Delay Time	t _{d(OFF)}	I _D = 20 A, R _G = 4.7 Ω, T _J = 25°C, (Notes 4, 5)		35		1
Rise Time	t _r			15		
Fall Time	t _f			9.6		
Turn-On Switching Loss	E _{ON}			51		μJ
Turn-Off Switching Loss	E _{OFF}			29		
Total Switching Loss	E _{TOT}			80	1	

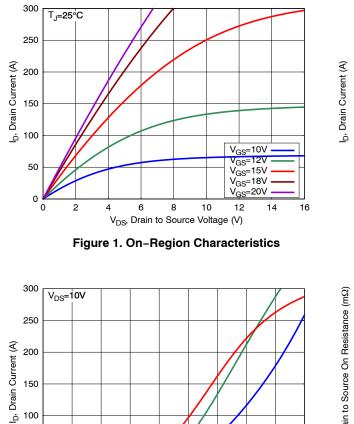
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

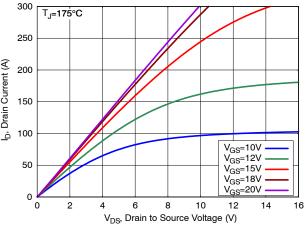
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS		·				
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 400 \text{ V},$		9.6		ns
Turn-Off Delay Time	t _{d(OFF)}	I _D = 20 A, R _G = 4.7 Ω, T _J = 175°C, (Notes 4, 5)		41		
Rise Time	t _r			14		
Fall Time	t _f			12		
Turn-On Switching Loss	E _{ON}			51		μJ
Turn–Off Switching Loss	E _{OFF}			45		
Total Switching Loss	E _{TOT}]		96		
SOURCE-TO-DRAIN DIODE CHA	RACTERISTICS	·	•	-	-	-
Forward Diada Valtaga	M			4.5	0.0	V

Forward Diode Voltage	V _{SD}	V_{GS} = –3 V, I_{SD} = 20 A, T_{J} = 25°C	4.5	6.0	V
		V_{GS} = -3 V, I _{SD} = 20 A, T _J = 175°C	4.2		
Reverse Recovery Time	t _{RR}	$V_{GS} = -3 \text{ V}, \text{ I}_{S} = 20 \text{ A},$	19		ns
Charge Time	t _a	dl/dt = 1000 A/μs, V _{DS} = 400 V (Note 5)	11		
Discharge Time	t _b]	8		
Reverse Recovery Charge	Q _{RR}]	97		nC
Reverse Recovery Energy	E _{REC}]	8.7		μJ
Peak Reverse Recovery Current	I _{RRM}		11		А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. E_{ON}/E_{OFF} result is with body diode.
5. Defined by design, not subject to production test.

TYPICAL CHARACTERISTICS







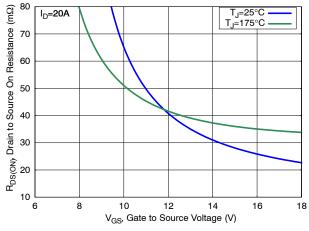


Figure 3. Transfer Characteristics Figu

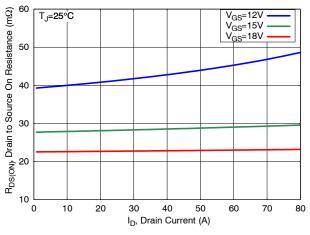
18

-55°C

16

Ť_J=25°C T_J=175°C

14



50

0

0

2

4

6

8

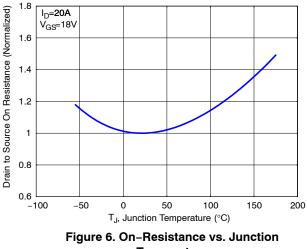
10

V_{GS}, Gate to Source Voltage (V)

12

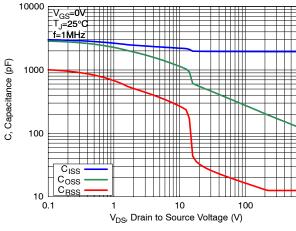
Figure 5. On-Resistance vs. Drain Current

Figure 4. On-Resistance vs. Gate Voltage



Temperature

TYPICAL CHARACTERISTICS





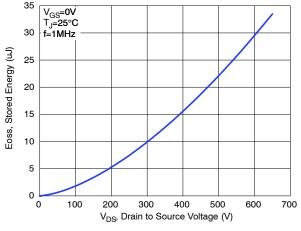


Figure 8. Stored Energy vs. Drain-to-Source Voltage

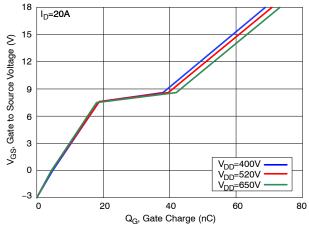


Figure 9. Gate Charge Characteristics

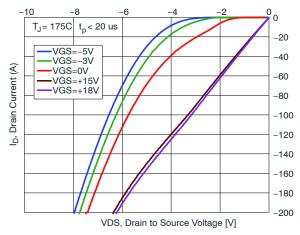


Figure 11. Reverse Conduction Characteristics

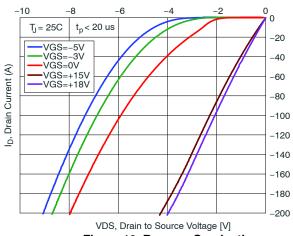


Figure 10. Reverse Conduction Characteristics

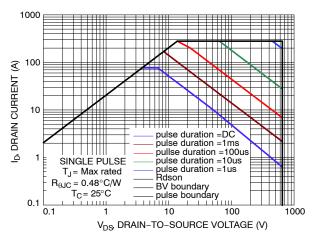
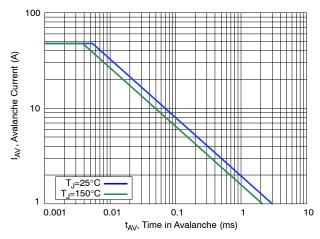
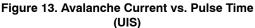
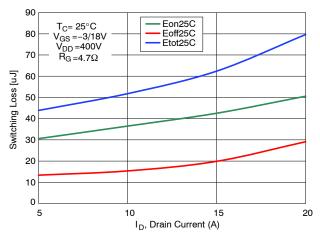


Figure 12. Safe Operating Area

TYPICAL CHARACTERISTICS









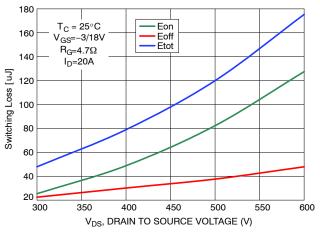


Figure 17. Switching Loss vs. Drain Voltage

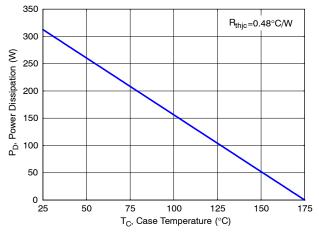


Figure 14. Maximum Power Dissipation vs. Case Temperature

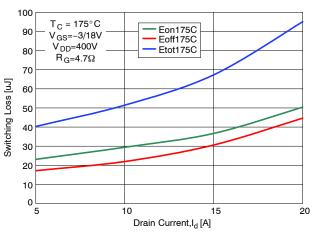


Figure 16. Switching Loss vs. Drain Current

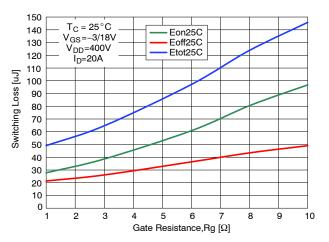


Figure 18. Switching Loss vs. Gate Resistance

TYPICAL CHARACTERISTICS

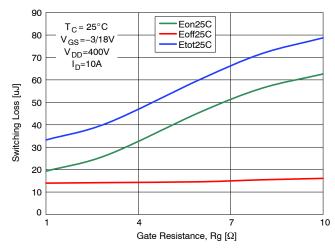


Figure 19. Switching Loss vs. Gate Resistance

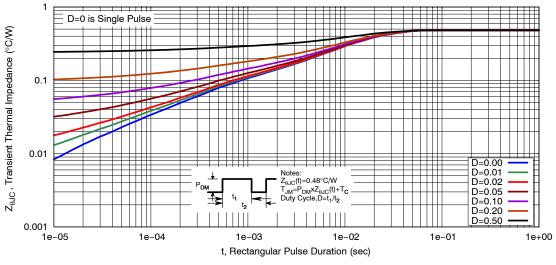


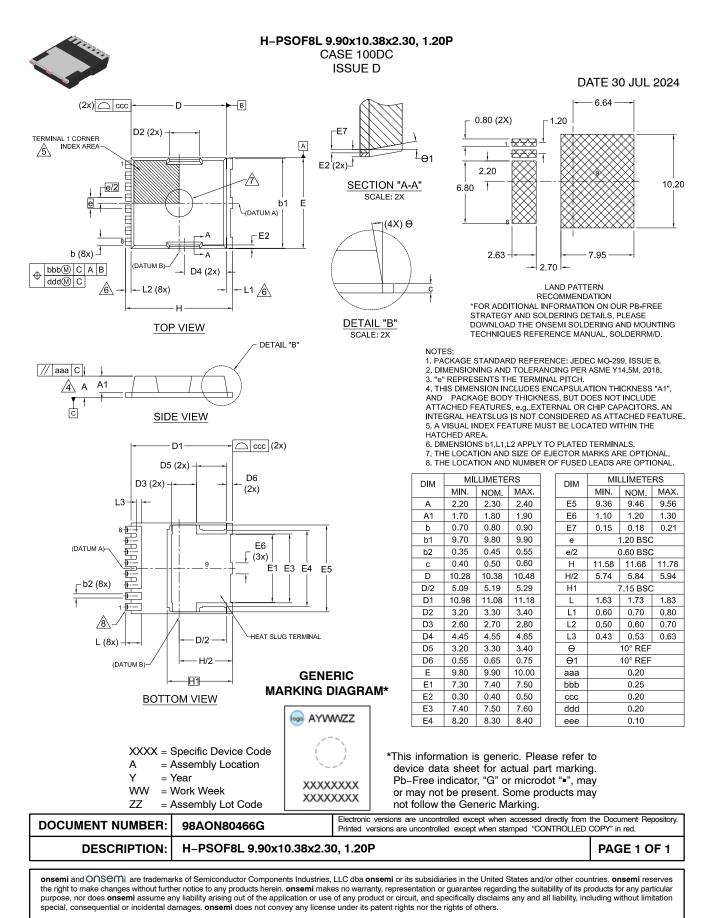
Figure 20. Thermal Response Characteristics

DEVICE ORDERING INFORMATION

Device	Package	Shipping [†]
NTBL023N065M3S	H-PSOF8L	2000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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